

Features

- IEC 61000-4-2 (ESD): Air – $\pm 15\text{kV}$, Contact – $\pm 8\text{kV}$
- 2 Channels of ESD Protection
- Low Channel Input Capacitance of 0.85pF Typical
- Typically Used at High Speed Ports such as USB 2.0, IEEE1394, Serial ATA, DVI, HDMI, PCI
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**

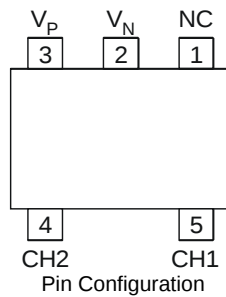
Mechanical Data

- Case: SOT353
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208 
- Weight: 0.006 grams (approximate)

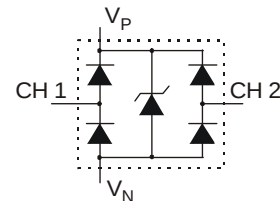
SOT353



Top View



Pin Configuration



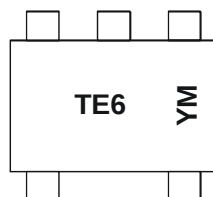
Device Schematic

Ordering Information (Note 4)

Part Number	Case	Packaging
D1213A-02S-7	SOT353	3000/Tape & Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
 2. See <http://www.diodes.com> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <http://www.diodes.com>.

Marking Information



TE6 = Product Type Marking Code
YM = Date Code Marking
Y = Year (ex: Z = 2012)
M = Month (ex: 9 = September)

Date Code Key

Year	2011	2012	2013	2014	2015	2016	2017
Code	Y	Z	A	B	C	D	E

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Operating Supply Voltage	V _P - V _N	6.0	V	-
DC Voltage at any Channel Input	-	(V _N - 0.5) to (V _P + 0.5)	V	-
Peak Pulse Current	I _{PP}	5	A	8/20μs, Per Figure 3
ESD Protection – Contact Discharge	V _{ESD Contact}	±8	kV	Standard IEC 61000-4-2
ESD Protection – Air Discharge	V _{ESD Air}	±15	kV	Standard IEC 61000-4-2

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P _D	400	mW
Thermal Resistance, Junction to Ambient (Note 5)	R _{θJA}	310	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Conditions
Operating Supply Voltage	V _P	-	3.3	5.5	V	-
Operating Supply Current (Note 6)	I _P	-	-	8.0	μA	(V _P - V _N) = 3.3V
Channel Leakage Current (Note 6)	I _R	-	±0.1	±1.0	μA	V _P = 5V, V _N = 0V
Reverse breakdown voltage	V _{BR}	6.0	-	-	V	I _R = 1mA
Clamping Voltage, Positive Transients	V _{CL1}	-	10.0	-	V	I _{PP} = 1A, t _p = 8/20μs
Clamping Voltage, Negative Transients	V _{CL2}	-	-1.7	-	V	I _{PP} = -1A, t _p = 8/20μs
Forward Voltage for Top Diode	V _{FD1}	0.60	0.80	0.95	V	I _F = 8mA, CH1 to V _P or CH2 to V _P
Forward Voltage for Bottom Diode	V _{FD2}	0.60	0.80	0.95	V	I _F = 8mA, V _N to CH1 or V _N to CH2
Dynamic Resistance	R _{DYN}	-	0.9	-	Ω	I _{PP} = 1A, t _p = 8/20μs
Channel Input Capacitance	C _T	-	0.85	1.2	pF	V _{IN} = 1.65V, V _P = 3.3V, V _N = 0V, f = 1MHz

- Notes:
- Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at <http://www.diodes.com>.
 - Short duration pulse test used to minimize self-heating effect.
 - Measured from CH1 to V_N or CH2 to V_N.
 - Measured from V_P to V_N.
 - For information on the impact of Diodes' USB 2.0 compatible ESD protectors on signal integrity including eye diagram plots, please refer to AN77 at the following URL: http://www.diodes.com/destdtools/appnote_dnote.html.

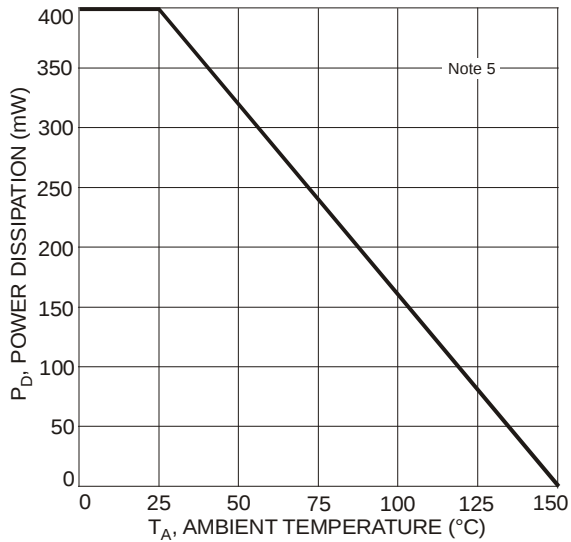


Figure 1 Power Dissipation vs. Ambient Temperature

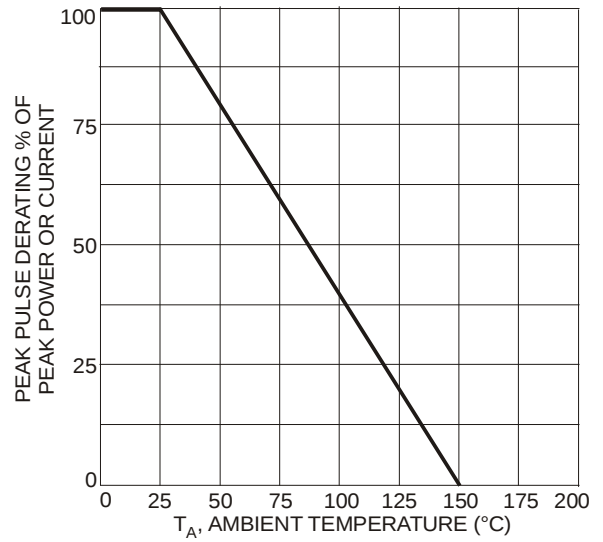


Figure 2 Pulse Derating Curve

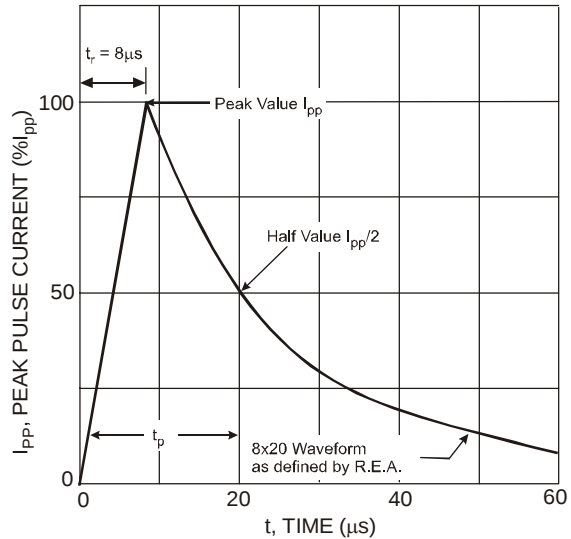


Figure 3 Pulse Waveform

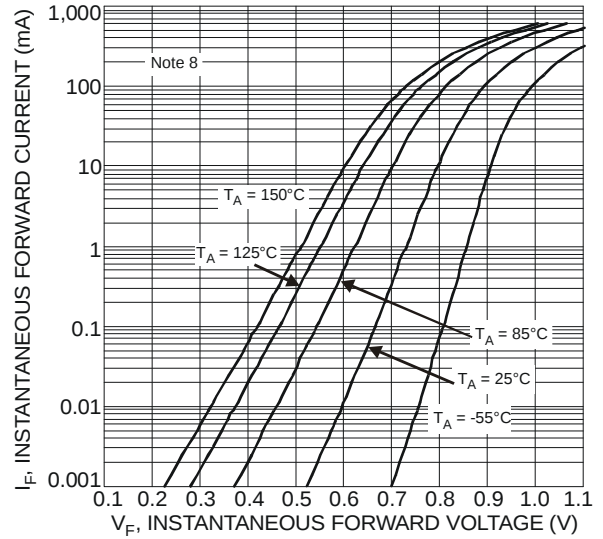


Figure 4 Typical Forward Characteristics

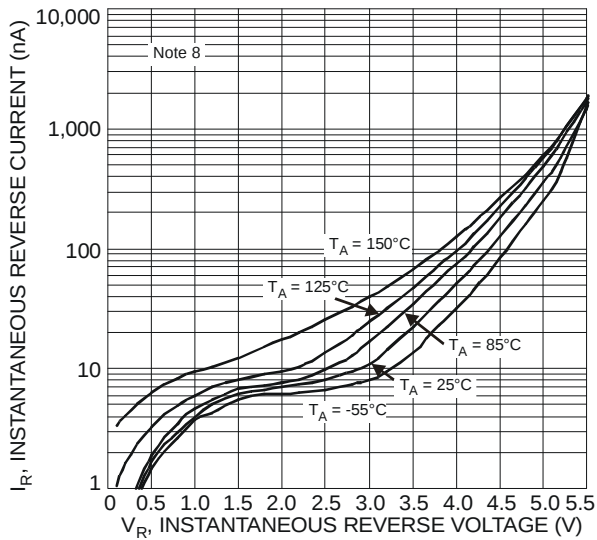


Figure 5 Typical Reverse Characteristics

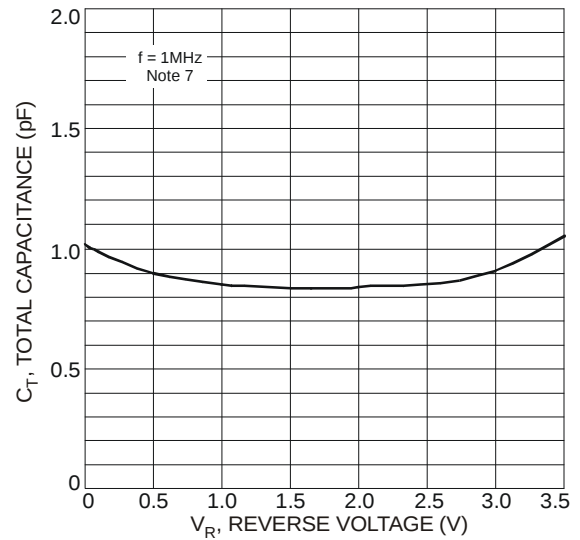
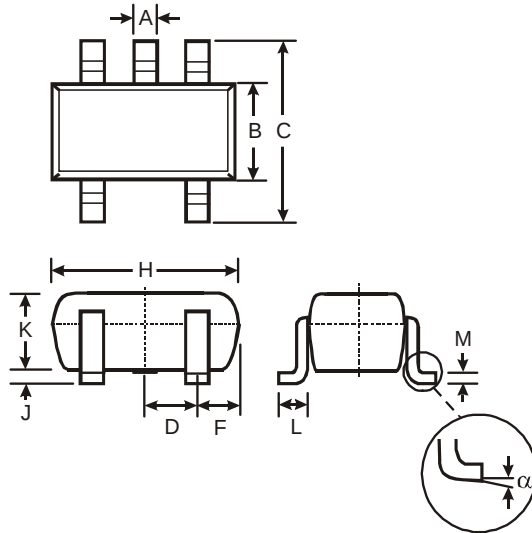


Figure 6 Typical Total Capacitance vs. Reverse Voltage

Package Outline Dimensions

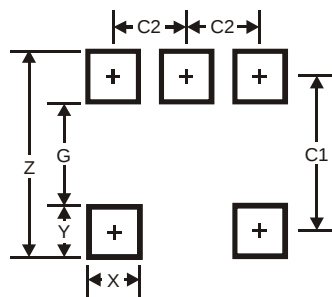
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for latest version.



SOT353		
Dim	Min	Max
A	0.10	0.30
B	1.15	1.35
C	2.00	2.20
D	0.65 Typ	
F	0.40	0.45
H	1.80	2.20
J	0	0.10
K	0.90	1.00
L	0.25	0.40
M	0.10	0.22
α	0°	8°
All Dimensions in mm		

Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
Z	2.5
G	1.3
X	0.42
Y	0.6
C1	1.9
C2	0.65

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